

Features

- For surface mounted application
- Low forward voltage drop
- High current capability
- High reliability
- Classification Rating 94V- 0



Mechanical Data

- Case: Molded plastic SMA
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Marking: Type Number

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified
 Single phase, half wave, 60Hz, resistive or inductive load
 For capacitive load derate current by 20%

Type Number	SYMBOL	M1	M2	M3	M4	M5	M6	M7	Unit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Average Rectified Output Current @ $T_L = 100^\circ C$	$I_{F(AV)}$	1.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave @ $T_j = 25^\circ C$ Superimposed On Rated Load (JEDEC Method)	I_{FSM}	30 24							A
Non-Repetitive Peak Forward Surge Current 1.0ms Single half sine-wave @ $T_j = 125^\circ C$ Superimposed On Rated Load (JEDEC Method)	I_{FSM}	60 48							A
10000 times of the wave surge current (time width 1ms, time interval 3s)	I_{FSM}	22.5							A
Rating for fusing ($t < 8.3ms$)	$I^2 t$	3.74							$A^2 s$
Forward Voltage @ $I_F = 1.0A$	V_{FM}	1.0							V
Peak Reverse Current @ $T_A = 25^\circ C$	I_R	5.0							uA
At Rated DC Blocking Voltage @ $T_A = 125^\circ C$		50							
Typical Junction Capacitance (Note 1)	C_J	12							pF
Typical reverse recovery time (Note 2)	T_{rr}	1.5							ns
Typical Thermal Resistance	$R_{\theta JL}$ $R_{\theta JA}$	23 57							$^\circ C/W$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150							$^\circ C$

Note:

1. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C
2. Reverse Recovery Test Conditions: $I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 0.25A$

Fig. 1 Forward Current Derating Curve

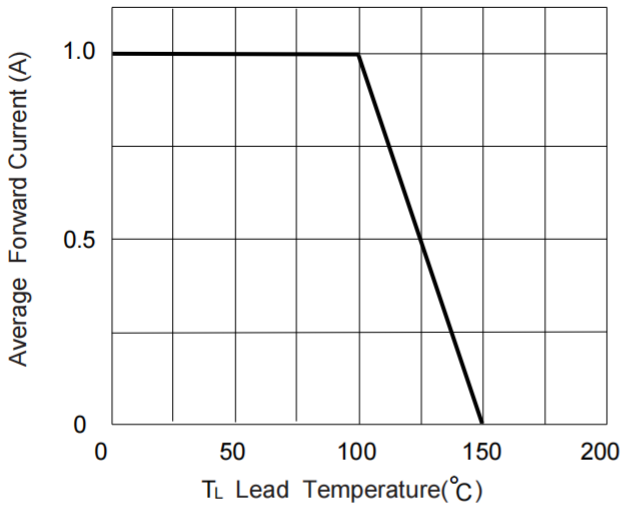


Fig. 2 Typ. Forward Characteristics

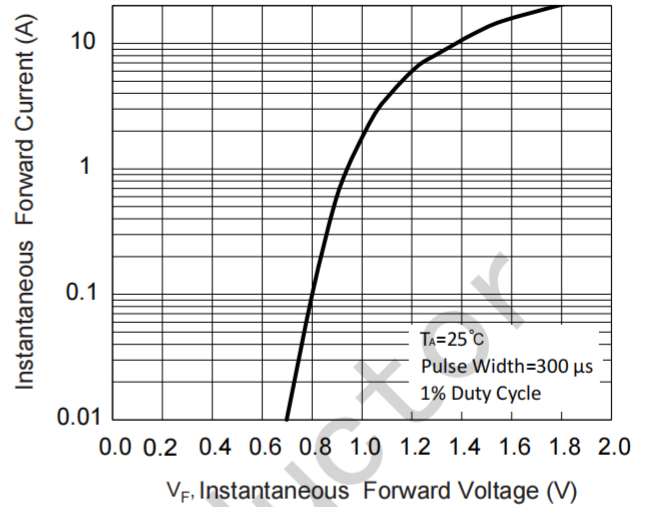


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

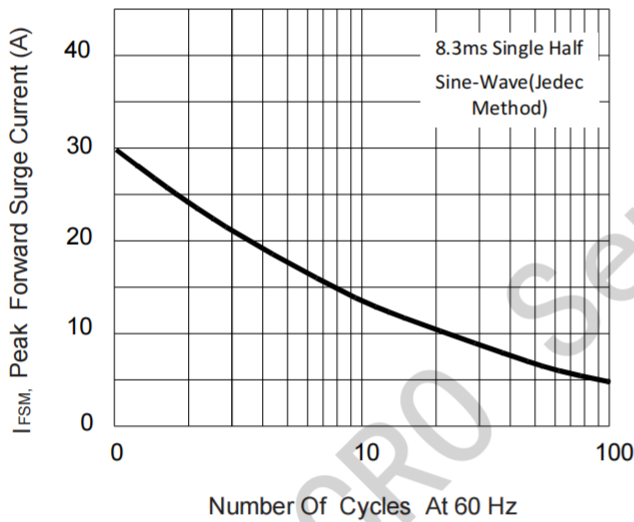


Fig.4 Typical Reverse Characteristics

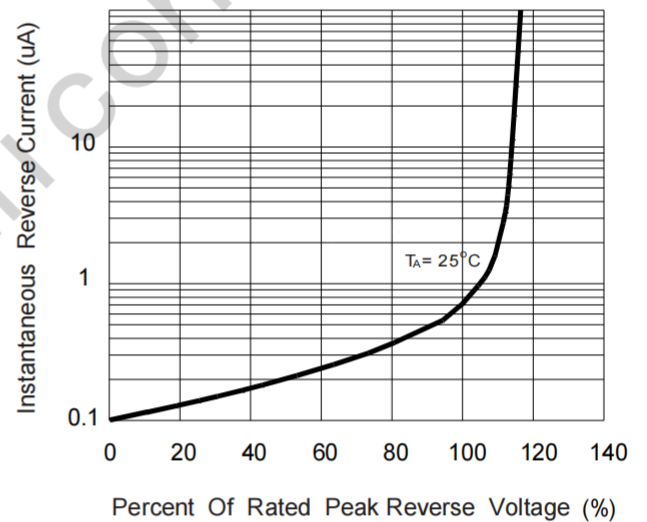


Fig.5 Typical Junction Capacitance

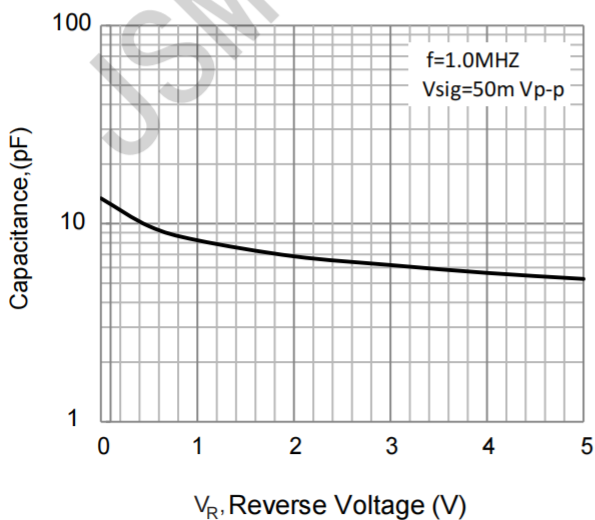
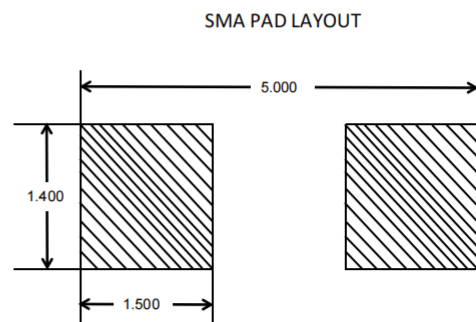


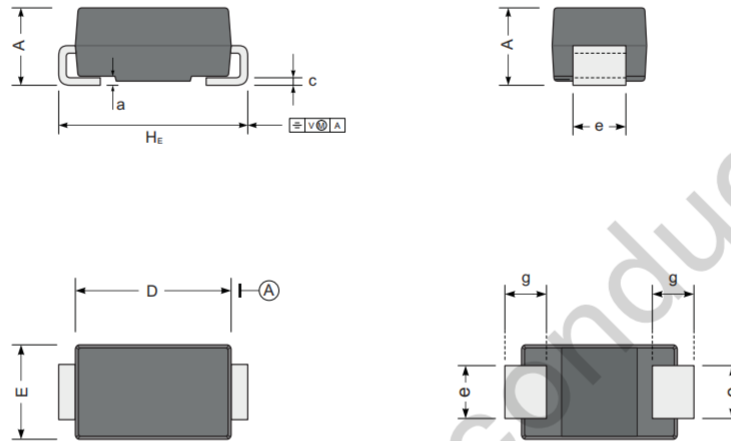
Fig.6 Mounting PAD Layout



Package Information

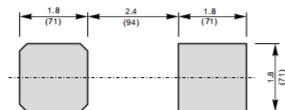
SMA

Plastic surface mounted package; 2 leads



UNIT		A	D	E	H _E	c	e	g	a
mm	max	2.2	4.5	2.7	5.2	0.31	1.6	1.5	0.3
	min	1.9	4.0	2.3	4.7	0.15	1.3	0.9	
mil	max	87	181	106	205	12	63	59	12
	min	75	157	91	185	6	51	35	

The recommended mounting pad size



Unit : $\frac{\text{mm}}{\text{mil}}$

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